TF-1/2 is a kind of circuit laminate based on the Teflon (which have excellent microwave and temperature resistance performance) compound with ceramic. This kind of laminate can be comparable with the products (such as RT/duroid 6006/6010/TMM10) from Rogers Corporation in United State of America.

The advantage of design for microwave circuit using TF-1/2 here :

(1) The operating temperature is much higher than TP-series. It is applicable to long-term operation within temperature ranger of -80°C ~

+200°C , and can be used for wave-welding and melt-back welding.

(2) Used for the manufacturing of the microwave and millimeter wave printed circuit board .

(3) Better radiation performance, 30min20rad/cm2.

(4) Dielectric property is stable and has a slight variation with the rise of temperature and frequency. ($\epsilon r=3.0$; 6.0; 9.2; 9.6; 10.2; 16; 20;

22)

Technical Specifications :

Appe Meet the general requirement for laminate of microwave PCB.

aran	150×150 250×250							
се	Thickness and tolerance are same as TP-series. For special dimension, customized laminates is available.							
Dime	Peel strength	≥ 8N/cm						
nsio	Warp	Same as TP-series.						
n	Cutting/punching							
(m	Strength	No burrs after cutting , minimum space between two punching he	mm.					
m)	According to the properties of laminate, the chemical etching method for PCB can be used. The dielectric properties of laminate are							
Mec	not changed. The plating through hole can be done.							
hani	Name	Test condition		Value				
cal	Density	Normal state	g/ cm3	2.0~3.5				
Stre	Moisture Absorption	Dip in the distilled water of 20±2°C for24 hours	%	≤0.02				
ngth		High-low temperature chamber		-80 °C ~				
Che	Operating Temperature			+260°C				
mical	Thermal Conductivity		W/m/k	0.5				

Prop					50 (x)
erty	CTE	-55~288°C		ppm/°C	50 (y)
					60 (z)
Elect	Shrinkage Factor	2 hours in boiling water		%	0.0001
rical		50	Normal state		≥1×105
Prop erty	Surface Resistivity	0 V D C	Constant humidity and temperature	M·Ω	≥1×103
	Volume Resistivity	Normal state		- MΩ.cm	≥1×105
		Constant humidity and temperature			≥1×104
	Pin Resistance0V	50	Normal state		≥1×106
			Constant humidity and temperature	ΜΩ	≥1×104

		D C			
	Surface dielectric strength	Norr	mal state	d=1mm	≥1.6
		Constant humidity and temperature		(Kv/m m)	≥1.4
	Dielectric Constant	10G	ΗZ	εr	3.0; 6.0; 9.2;9.6; 10.2;16; 20;22 (±2%) (±2%) (can be customized)

			tg δ	
Dissipation Factor			(3~11	≤1×10-3
	10GHZ)	
			tg δ	
		(12~2	≤1.5×10-3	
			2)	



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